

Data Sheet	AMM-3742-T-R
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Specifications

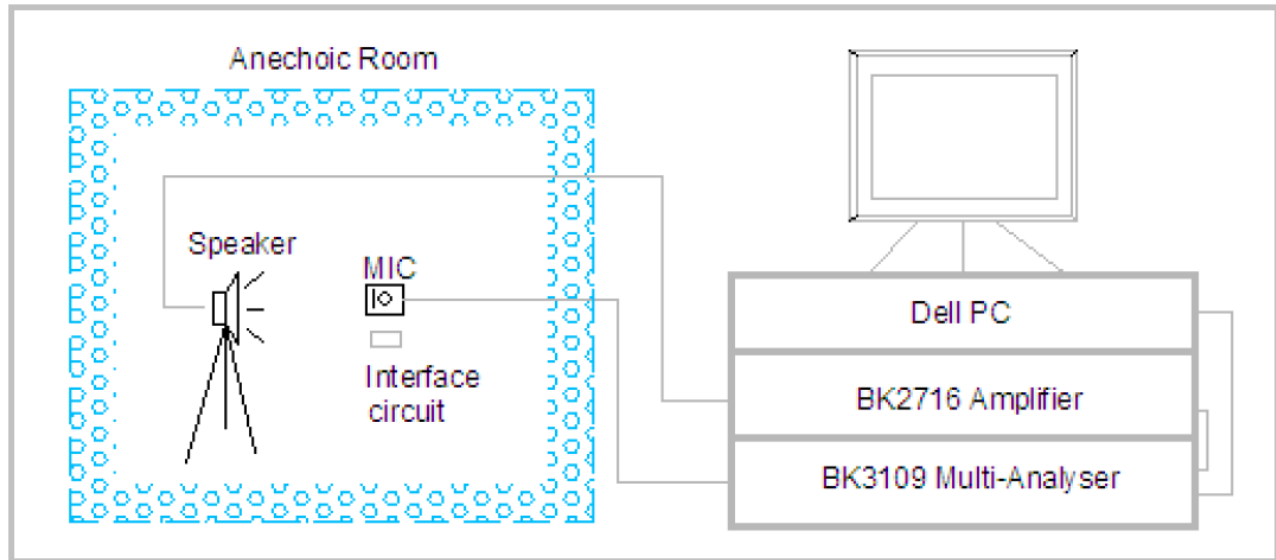
Parameters	Values	Units
Sensitivity (1 kHz @ 50cm) 0 dB=1V/Pa	-42±1	dB
Rated Voltage	1.5	VDC
Operating Voltage Range	1.5 to 3.6	VDC
Output Impedance (@ 1 kHz)	300	Ω
Current consumption (at 1.8 VDC/at 3.6 VDC)	90/200	μA
Signal-to-Noise Ratio (1kHz, 94 dB input, A-weighted)	58	dB
Decreasing Voltage (0 dB=1V/Pa, 3.6 to 1.5 VDC)	0.5	dB
Frequency Range	50 – 20,000	Hz
Total Harmonic Distortion (94 dB @ 50cm, 1 kHz)	0.5%	-
Acoustic Overload Point (AOP) (50cm, 1kHz, 10% THD)	125	dB
Directivity	Omnidirectional	
Acceptable Soldering Methods	Reflow Solder	See page 5 for soldering information
Environmental Compliances	RoHS/Halogen Free	
Power Supply Rejection (PSR, 100 mVpp Square Wave @ 217 Hz, A-weighted)	-90	dB
Weight	<0.3	Grams
Operating Temperature (VDD < 3 VDC)	-40 ~ +100	°C
Operating Temperature (VDD > 3 VDC)	-40 ~ +70	°C
Storage Temperature	-40 ~ +125	°C
MSL (Moisture Sensitivity Level)*	1	-

*MSL level dependent on product remaining in sealed packaging until use

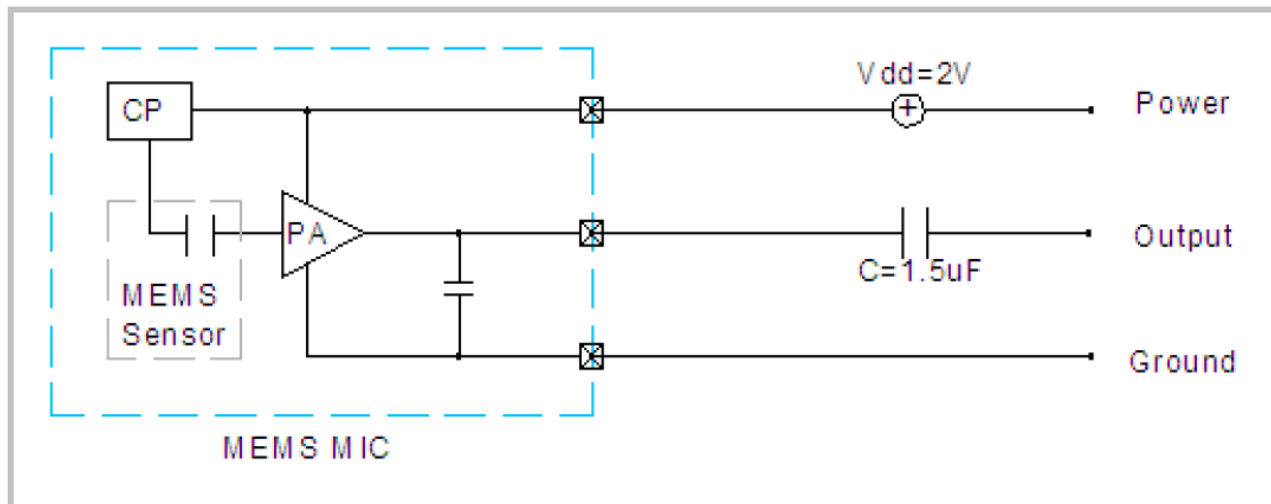
Absolute Maximum Ratings

Parameters	Values	Units
Max Voltage on Any Pin	4	VDC
Max Sound Pressure Level	160	dB
Max Mechanical Shock	10,000	Gs
Max Vibration	Pre-MIL-STD-883 Method 2007, Test Condition B	

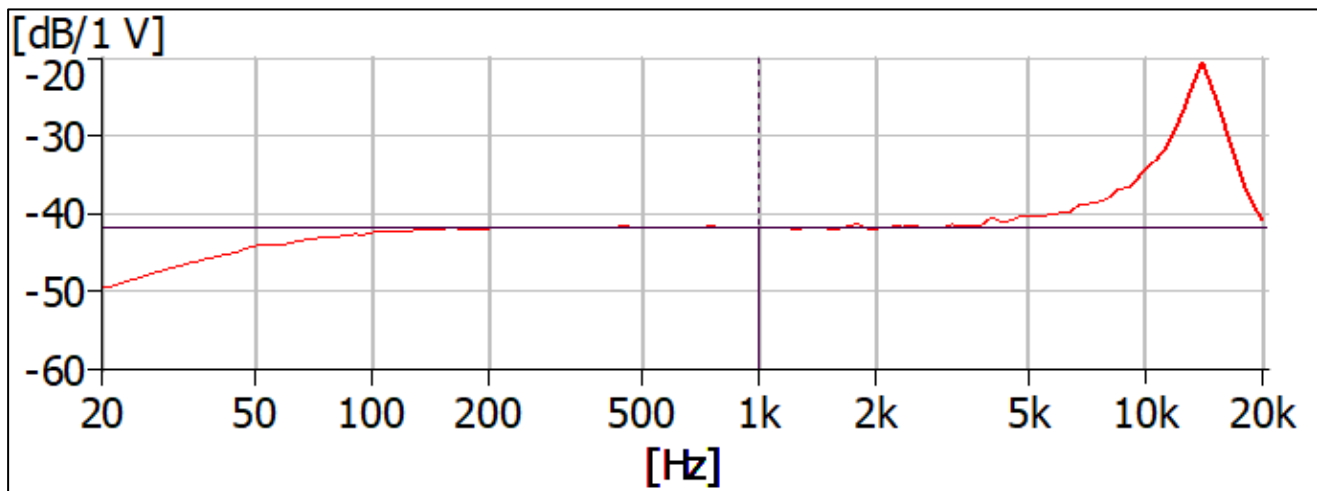
Measurement Method



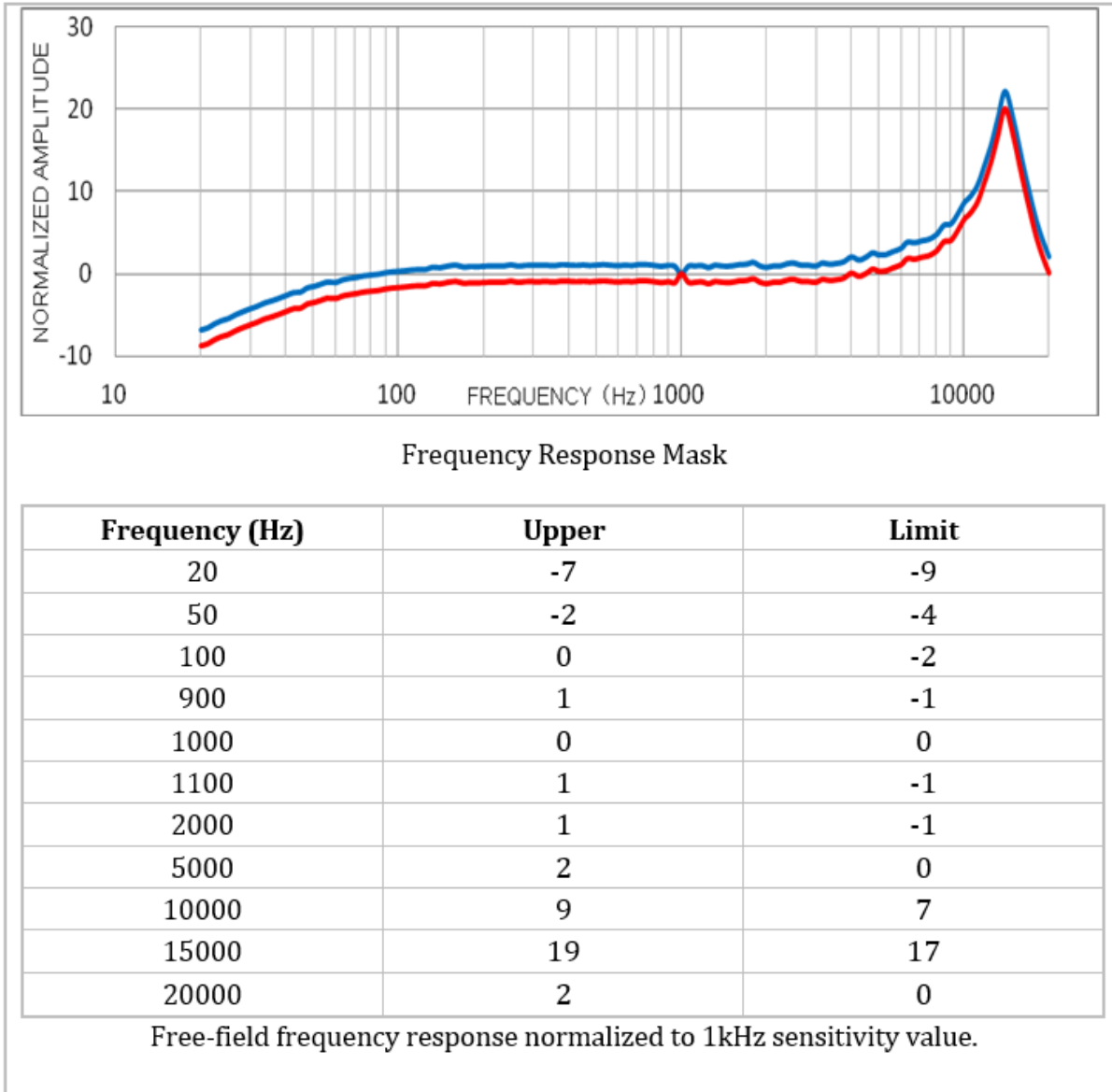
Recommended Drive Circuit



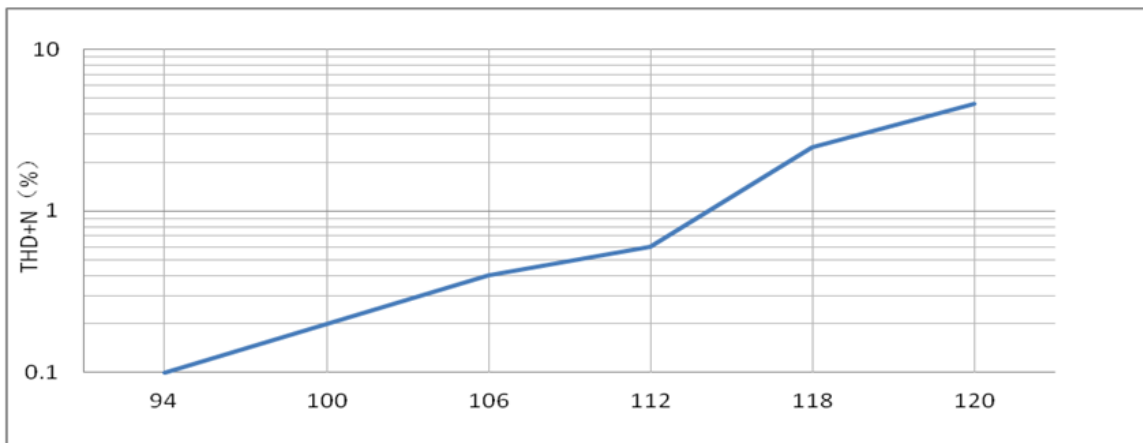
Typical Frequency Response



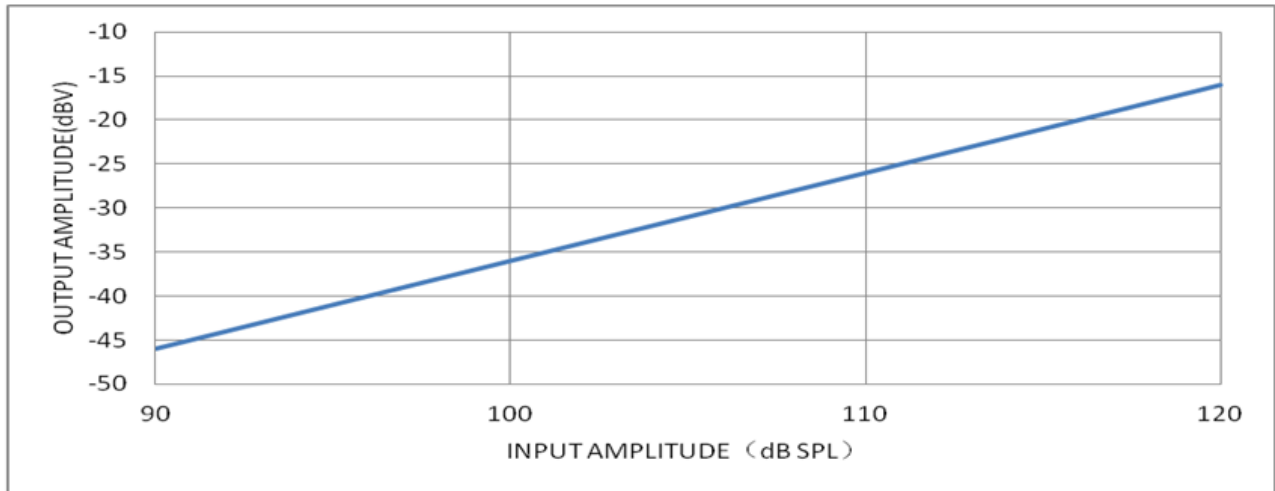
Frequency Response Mask (100% Pass/Fail Test for Microphones)



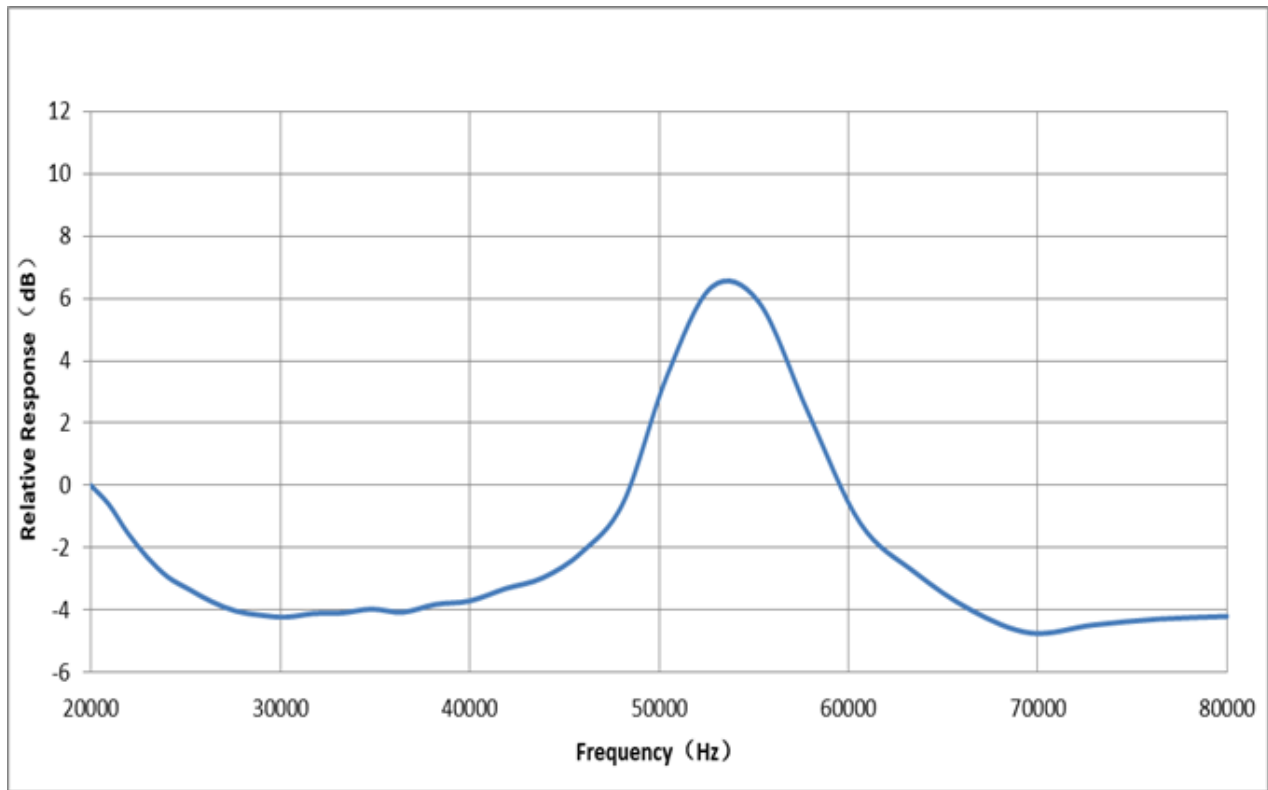
Total Harmonic Distortion + Noise versus SPL Input (with acoustic source at 50cm)



Microphone Output versus SPL Input (with acoustic source at 50cm)

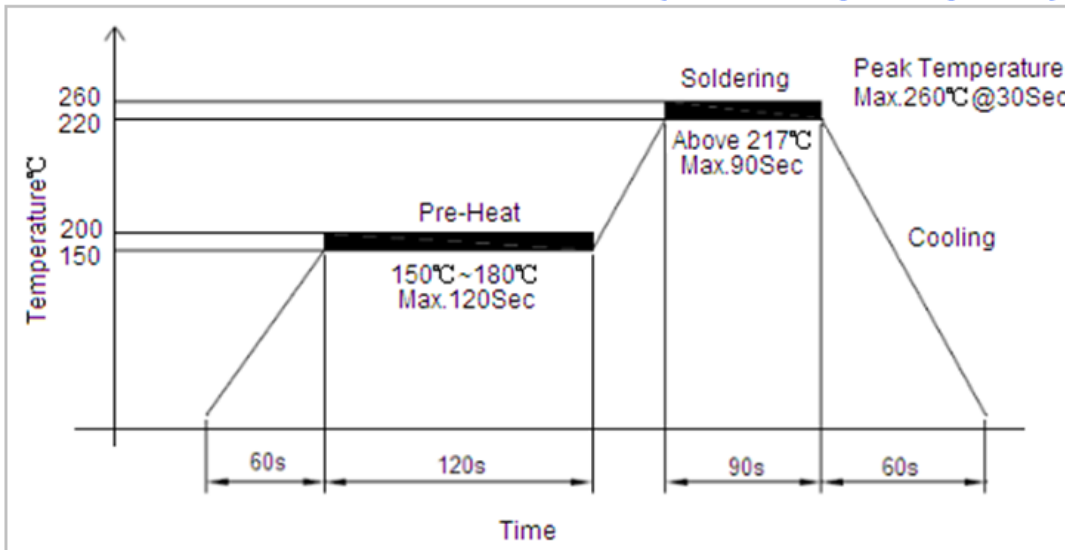


Ultrasonic Frequency Response (Sensitivity normalized to 0 dB)



Recommended Soldering Procedure

Recommend Reflow Profile, solder reflow $\leq 260^{\circ}\text{C}$ (for 30s Max of peak temperature).



Important Notes

In order to minimize device damage:

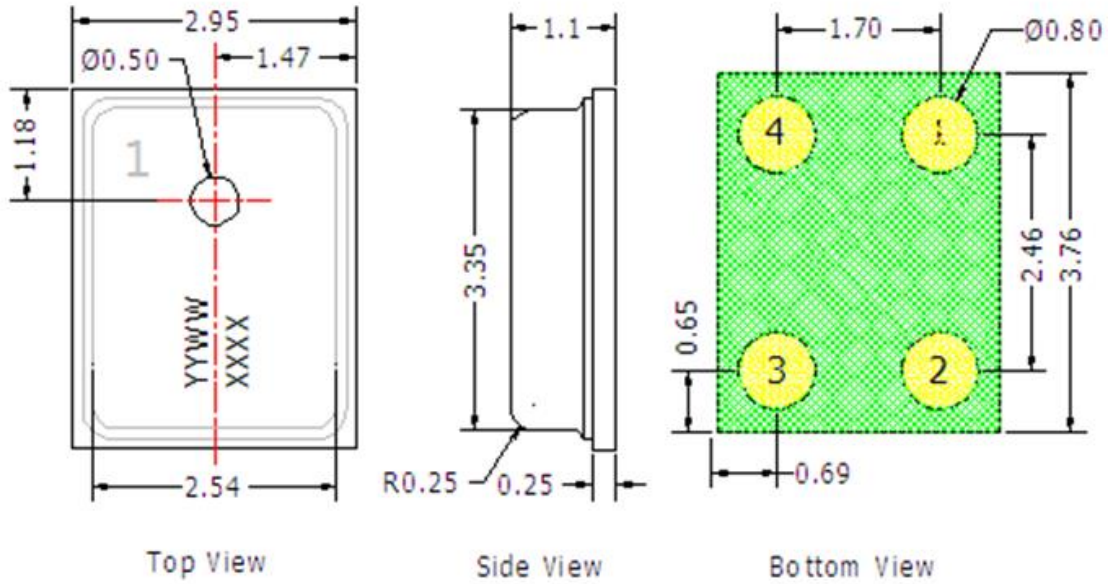
1. Do not wash or clean PCBAs after the reflow process.
2. Do not apply over 0.3Mpa of air pressure into the microphone sound hole.
3. Do not expose microphone to ultrasonic processing or cleaning.
4. Do not place a vacuum over the microphone sound hole.

Reliability Testing

Type of Test	Test Specifications
Simulated Reflow (Without Solder)	Samples for qualification testing require 3 passes 260±5 °C reflow solder profiles. 2 hours of setting time is required between each reflow profile test.
Static Humidity	Precondition at +25°C for 1 hour. Expose to +85°C with 85% relative humidity for 1000 hours. Finally, dry at room ambient for 3±1 hour before taking final measurement.
Temperature Shock	Each cycle shall consist of 30 minutes at -40°C, 30 minutes at +125°C with 5 minutes transition time. Test duration is for 30 cycles, starting from cold to hot temperature.
ESD Sensitivity	Perform ESD sensitivity threshold measurements for each contact according to MIL-STD-883G, Method 3015.7 for Human Body Model. Identify the ESD threshold levels indicating passage of 8000V Human Body Model.
Vibration Test	Vibrate randomly along three perpendicular directions for 30 minutes in each direction, 4 cycles from 20~2000 Hz with a peak acceleration of 20 Gs.
Shock Test	Subject samples to half-sine shock pulses (3000±15% Gs for 0.3ms) in each direction, for a total of 18 shocks.
Drop Test	Drop samples from 1.5m height onto a steel surface, total 18 times and inspected for mechanical damage.
Operation Life	Subject samples to +125°C for 168 hours under full maximum rated voltage.

Microphone frequency response and sensitivity shall not deviate more than ±3 dB.

Dimensions



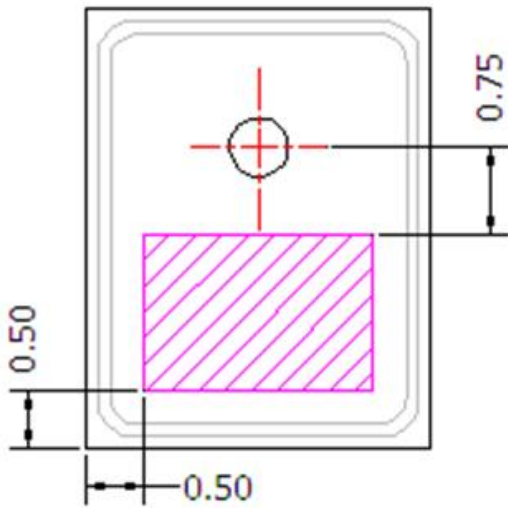
Data Code	
YYWW	YY:Year WW: Work Week
XXXX	XXXX: Lot No.

Item	Dimension	Tolerance (+/-)	Units
Length (L)	3.76	0.10	mm
Width (W)	2.95	0.10	mm
Height (H)	1.1	0.10	mm
Acoustic Port (AP)	$\varnothing 0.5$	0.05	mm

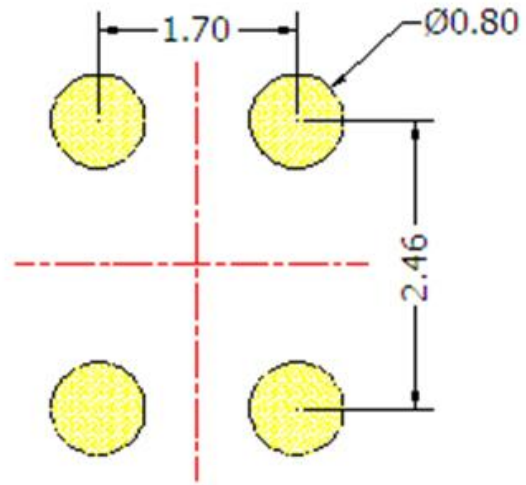
Pin #	Pin Name	Type	Description
1	Output	Signal	Output Signal
2	GND	Ground	Ground
3	GND	Ground	Ground
4	V _{DD}	Power	Power Supply

Notes:
 All dimensions are in millimeter (mm).
 Tolerance ± 0.15 mm unless otherwise specified.

Suggested Pickup Tool Location and Land Pattern*



Recommended Pickup Location

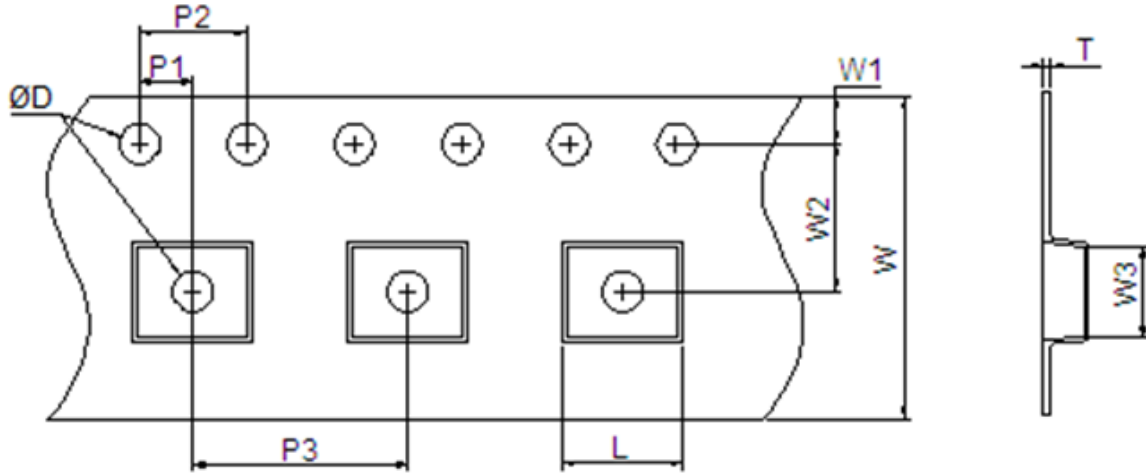


Recommended Solder Pad Layout

*This land pattern is advisory only and its use or adaptation is entirely voluntary. PUI Audio disclaims all liability of any kind associated with the use, application, or adaptation of this land pattern.

Packaging

Tape Specification



Symbol	Dimension		
	Minimum	Nominal	Maximum
ØD	1.5	1.5	1.6
P1	1.9	2.0	2.1
P2	3.9	4.0	4.1
P3	7.9	8.0	8.1
L	4.0	4.1	4.2
W	11.7	12	12.3
W1	1.65	1.75	1.85
W2	5.4	5.5	5.6
W3	3.3	3.4	3.5
T	0.25	0.3	0.35

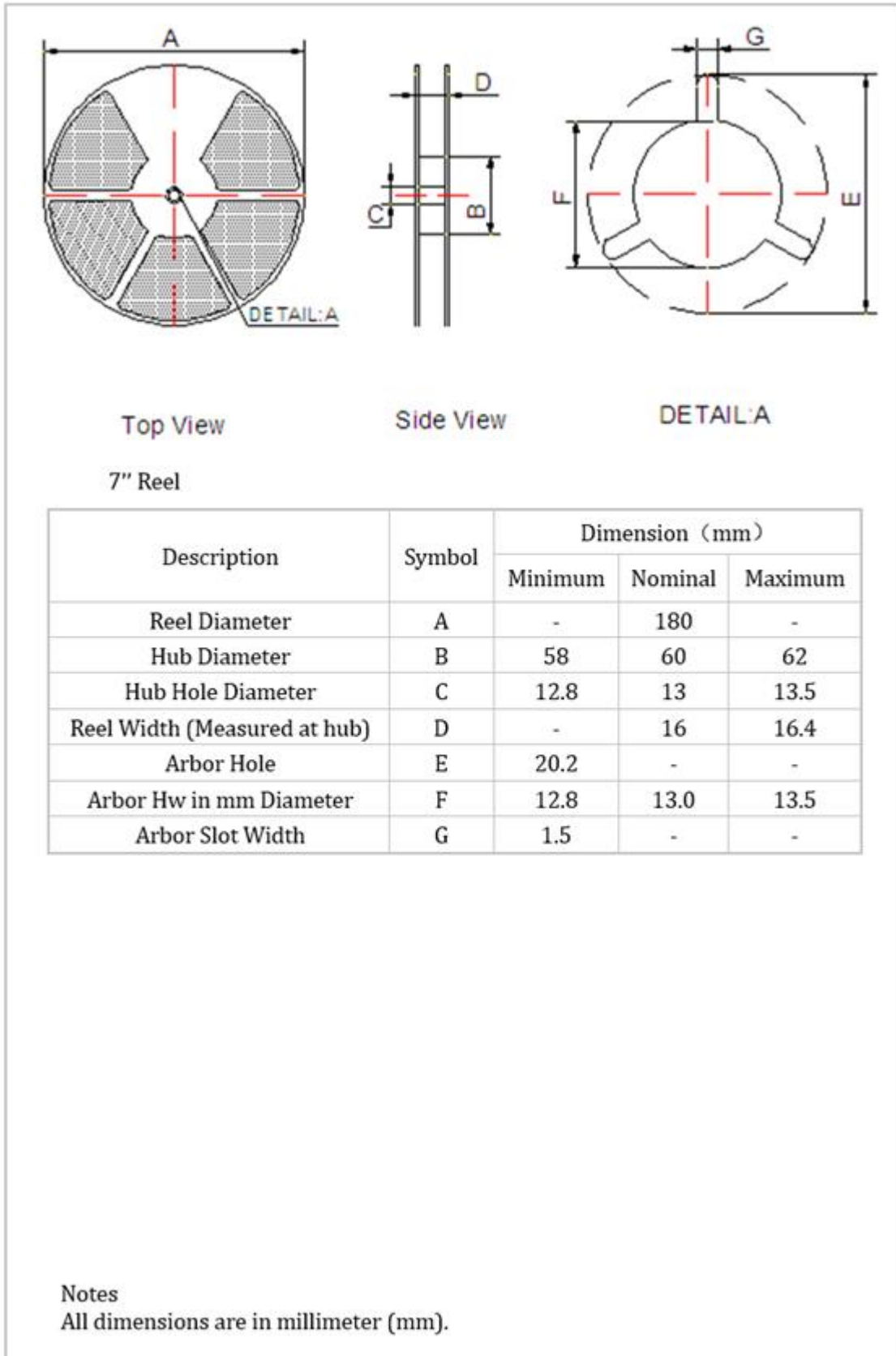
Notes

All dimensions are in millimeter (mm).

Tolerance $\pm 0.15\text{mm}$ unless otherwise specified.

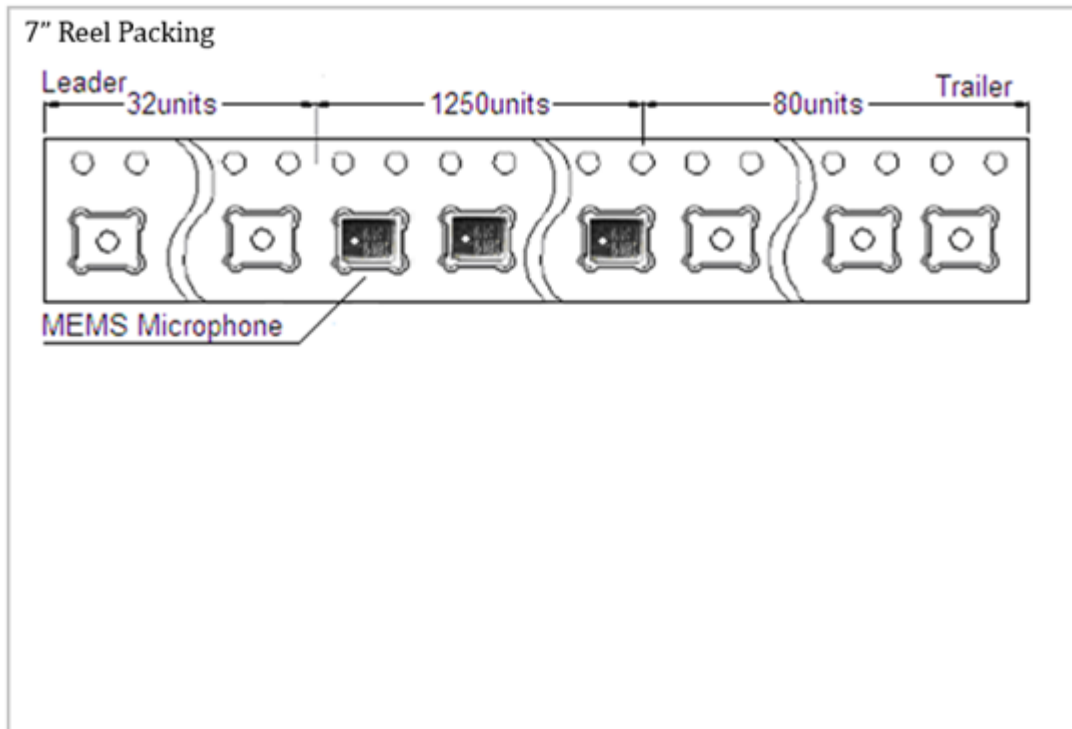
Packaging (continued)

Reel Specification

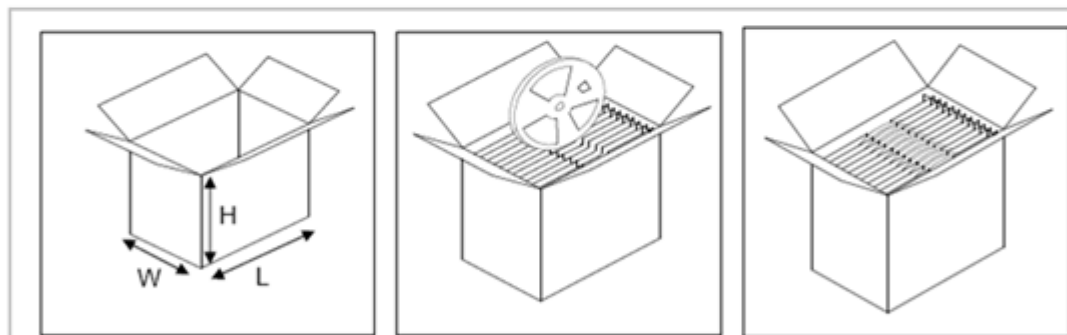


Packaging (continued)

Packing Quantity



Packing Information



Tape & Reel 7"

Qty/reel	Weight/reel	Reel/Carton	Qty/carton	Weight full	Dimension carton Box (L x W x H) mm	Storage
Pcs	Kg	Nos	Nos	Load(kg)		Temp
1250	0.25	4	5000	~3.00	272 x 159 x 236	-10°C~50 °C

Specifications Revisions

Revision	Description	Date
-	Released from Engineering	10/31/2019
A	Added Ultrasonic Response	5/19/2020

Note:

1. Unless otherwise specified:
 - A. All dimensions are in millimeters.
 - B. Default tolerances are $\pm 0.5\text{mm}$ and angles are $\pm 3^\circ$.
2. Specifications subject to change or withdrawal without notice.

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